

Product Discontinuation Notice for Development Systems Product

XCN10031 (v1.0) October 11, 2010

Product Discontinuation Notice

Overview

The purpose of this notification is to communicate that Xilinx is discontinuing certain Development Systems products.

Description

As part of standard Xilinx product review activities, the following products have been identified for obsolescence. This notice should be used in conjunction with previous discontinuance notices which can be found at http://www.xilinx.com/support/documentation/customer_notices.htm.

Products Affected

- 1. LogiCORE[™] IP, IEEE 802.16e LDPC Encoder
- 2. Virtex[®]-4 FX12 PowerPC® MicroBlaze™ Development Kit
- 3. Xilinx[®] Development Systems Kits and Boards Products on While Supplies Last

Table 1: LogiCORE, IEEE 802.16e LDPC Encoder

Part Number	Description	Replacement Part
EF-DI-80216E-LDPC-ENC-SITE	LogiCORE, IEEE 802.16e LDPC Encoder, Site License	No Replacement Available
EFR-DI-80216E-LDPC-ENC-SITE	LogiCORE, IEEE 802.16e LDPC Encoder, Site License Renewal	No Replacement Available

Table 2: Virtex-4 FX12 PowerPC MicroBlaze Development Kit

Part Number	Description	Replacement Part
DO-ML403-EDK-ISE-USB-UNI-G	PowerPC MicroBlaze™ Development Kit Virtex- 4 FX12 Edition With USB JTAG, Includes a Full Seat of EDK	DK-S6-EMBD-G DK-V6-EMBD-G
DO-ML403-EDK-ISE-USB-UNI-G-J	Virtex-4 FX12 PowerPC MicroBlaze Development Kit, Includes a Full Seat of EDK, Japan Specific	DK-S6-EMBD-G-J DK-V6-EMBD-G-J

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Table 3: Xilinx Development Systems Products on While Supplies Last

Part Number	Description	Suggested Replacement
HW-S3PCIE-DK	Spartan ® -3 PCI™ Express Design Kit	DK-S6-CONN-G-XP1
HW-AFX-BERG-SDRAM	Add-On Memory Module	No Xilinx Suggested Replacement
HW-AFX-BERG-EPHY	Add-On Ethernet Module	No Xilinx Suggested Replacement
HW-AFX-SMA-HSSDC2	SMA to HSSDC2 Conversion Module	No Xilinx Suggested Replacement
HW-AFX-SMA-NQSL-G	NELCO QUAD Serial Loop (Lead-Free)	No Xilinx Suggested Replacement
HW-AFX-SMA-RJ45	SMA to RJ45 Conversion Module	No Xilinx Suggested Replacement
HW-AFX-SMA-SATA	SMA to Serial ATA (SATA) Conversion Module	No Xilinx Suggested Replacement
HW-PCIE-SMA-G	PCIe® to SMA Conversion Module (Lead-Free)	No Xilinx Suggested Replacement
HW-AFX-FF665-500-G	Virtex®-5 Socketed Board Supporting Devices in FF665 Package (Lead-Free)	No Xilinx Suggested Replacement
HW-V4-ML423-UNI-G	Virtex -4 FX100 Characterization Board (Lead- Free)	<u>CK-V6-ML623-G</u>
HW-V4-ML423-UNI-G-J	Virtex-4 FX100 Characterization Board, Japan Specific (Lead-Free)	CK-V6-ML623-G-J
HW-V5-ML561-UNI-G	Virtex-5 Memory Development Board	No Xilinx Suggested Replacement
HW-V5-ML561-UNI-G-J	Virtex-5 Memory Development Board, Japan Specific	No Xilinx Suggested Replacement
HW-V5-ML521-UNI-G	Virtex-5 LX50T Characterization Board (Lead- Free)	<u>CK-V6-ML623-G</u>
HW-V5-ML521-UNI-G-J	Virtex-5 LX50T Characterization Board, Japan Specific (Lead-Free)	CK-V6-ML623-G-J
HW-V5-ML525-UNI-G	Virtex-5 LXT ML525 RocketIO™ Characterization Platform	<u>CK-V6-ML623-G</u>
HW-V5-ML525-UNI-G-J	Virtex-5 LXT FPGA ML525 RocketIO Characterization Platform, Japan Specific	CK-V6-ML623-G-J
HW-V5-ML525-FXT-UNI-G	Xilinx Virtex-5 FXT FF1738 RocketIO GTX Characterization Platform	<u>CK-V6-ML623-G</u>
HW-V5-ML525-FXT-UNI-G-J	Xilinx Virtex-5 FXT FF1738 RocketIO GTX Characterization Platform, Japan Specific	CK-V6-ML623-G-J
HW-V4-ML410-UNI-G	Virtex-4 Embedded System Development Board (Lead-Free)	<u>HW-V5-ML510-G</u>
HW-V4-ML410-UNI-G-J	Virtex-4 Embedded System Development Board, Japan Specific (Lead-Free)	<u>HW-V5-ML510-G-J</u>
HW-V5-ML550-UNI-G	Virtex-5 Networking Interface Board (Lead- Free)	No Xilinx Suggested Replacement
HW-V5-ML523-UNI-G	Virtex-5 LX110T Characterization Board (Lead- Free)	<u>CK-V6-ML623-G</u>
HW-V5-ML523-UNI-G-J	Virtex-5 LX110T Characterization Board, Japan Specific (Lead-Free)	CK-V6-ML623-G-J
HW-V5-ML523-FXT-UNI-G	Xilinx Virtex-5 FXT FF1136 RocketIO GTX Characterization Platform	CK-V6-ML623-G
HW-V5-ML523-FXT-UNI-G-J	Xilinx Virtex-5 FXT FF1136 RocketIO GTX Characterization Platform, Japan Specific	CK-V6-ML623-G-J
DO-DI-DSP-DK4-UNI-G	XtremeDSP Development Kit for Virtex-4, Includes Full Seat of ISE Design Suite: DSP Virtex-4 SX35 Device Locked Edition	Avnet Partner Board: AES-V6DSP-LX240T-G

NOTE:

Reference designs provided with all the above Development Systems are intended to be used as is.
The last version of design environment to support the reference designs is ISE[®] 11.1.

Key Dates and Ordering Information

LogiCORE, IEEE 802.16e LDPC Encoder

Final orders accepted until November 5th, 2010. Final orders shipped by November 12th, 2010. No technical support available after November 5th, 2011. Existing Warranty Contracts will be honored after product discontinuance but will not be renewable.

Virtex-4 FX12 PowerPC MicroBlaze Development Kit

Final orders accepted until December 1st, 2010. Final orders shipped by December 15th, 2010. No technical support available after May 3rd, 2011.

Multiple Xilinx Development Systems Kits and Boards

Available While Supplies Last: The products listed are in stock, but will NOT be replenished when inventory has been depleted. When this occurs the product will be discontinued and no longer available for order.

Six months after the obsolescence process begins no technical support will be available for the product.

Response

Customers are requested to place last-time-buy orders in a timely manner prior to the key dates listed above to avoid product availability issues. If you anticipate that your last time buy requirements will exceed the current rate, please provide your Xilinx Sales Representative with a forecast of the requirements. All orders will be supported on a first-come, first-served basis with the non-cancellable and non-returnable (NCNR) condition. For additional information or questions, contact your local <u>Xilinx Sales representative</u> or <u>Distributor</u>.

Important Notice: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<u>http://www.xilinx.com/support</u>). Register today and personalize your "Documentation and Design Advisory Alerts" area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to <u>Xilinx Answer Record</u> <u>18683</u>.

Revision History

The following table shows the revision history for this document:

Date	Version	Description of Revisions
10/11/10	1.0	Initial release.

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